19-0438: Rev 0: 9/95



### 

### 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### General Description

The MAX608 low-voltage step-up controller operates from a 1.8V to 16.5V input voltage range. Pulse-frequency-modulation (PFM) control provides high efficiency at heavy loads, while using only 85µA (typical) when operating with no load. In addition, a logic-controlled shutdown mode reduces supply current to 2µA typical. The output voltage is factory-set at 5V or can be adjusted from 3V to 16.5V with an external resistor

The MAX608 is ideal for two- and three-cell batterypowered systems. An operating frequency of up to 300kHz allows use with small surface-mount compo-

The MAX608 operates in "bootstrapped" mode only (with the chip supply, OUT, connected to the DC-DC output). For a 12V output without external resistors, or for nonbootstrapped applications (chip supply connected to input voltage), refer to the pin-compatible MAX1771. The MAX608 is available in 8-pin DIP and SO packages.

### **Features**

- 1.8V to 16.5V Input Range
- 85% Efficiency for 30mA to 1.5A Load Currents
- **Up to 10W Output Power**
- 110µA Max Supply Current
- 5µA Max Shutdown Current
- Preset 5V or Adjustable Output (3V to 16.5V)
- **Current-Limited PFM Control Scheme**
- Up to 300kHz Switching Frequency
- **Evaluation Kit Available**

### **Applications**

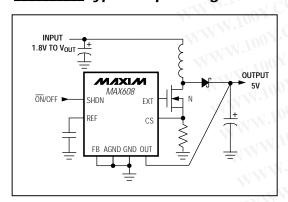
High-Efficiency DC-DC Converters **Battery-Powered Applications** Positive LCD-Bias Generators Portable Communicators

### Ordering Information

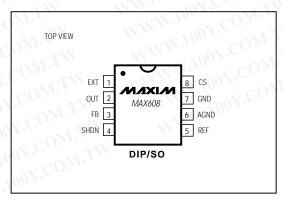
PART	TEMP. RANGE	PIN-PACKAGE
MAX608C/D	0°C to +70°C	Dice*
MAX608EPA	-40°C to +85°C	8 Plastic DIP
MAX608ESA	-40°C to +85°C	8 SO
- T		

<sup>\*</sup> Contact factory for dice specifications.

### **Typical Operating Circuit**



### Pin Configuration



MIXIM

Maxim Integrated Products 1

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# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage
OUT to GND0.3V, 17V
EXT, CS, REF, SHDN, FB to GND0.3V, (Vout + 0.3V)
GND to AGND
Continuous Power Dissipation (T <sub>A</sub> = +70°C)
Plastic DIP (derate 9.09mW/°C above +70°C)727mW
SO (derate 5.88mW/°C above +70°C)471mW

Operating Temperature Range	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +160°C
Lead Temperature (soldering, 10sec).	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{OUT} = 5V, I_{LOAD} = 0mA, T_A = -40^{\circ}C$  to  $+85^{\circ}C$  where indicated.  $T_A = -25^{\circ}C$  to  $+85^{\circ}C$  for all other limits. Typical values are at  $T_A = +25^{\circ}C$ .)

PARAMETER	SYMBOL	CONTRACTOR	ONDITIONS	MIN	TYP	MAX	UNITS
Input Voltage Range	Tran	$T_A = -25^{\circ}C \text{ to } +85^{\circ}C$	TANN.I	1.8	7.	16.5	V
(Note 2)	-1100	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	(Note 1)	1.9	$M_{i,I}$	16.5	1
Minimum Start-Up Voltage	W	No load	MM	V.Co	1.6	1.8	٧
N.	J. 10	V <sub>OUT</sub> = 16.5V,	$T_A = -25^{\circ}C \text{ to } +85^{\circ}C$	-1 C	85	110	μА
Supply Current	1	SHDN≤0.4V	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 1)}$	10 1.	Mo.	120	μΑ
Supply Current	MM	V <sub>OUT</sub> = 10V,	$T_A = -25$ °C to $+85$ °C	any.C	2	5	μА
	TXN	SHDN≥1.6V	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 1)}$	100	CON	10	μΑ
Output Valtage (Note 2)	MM	$V_{IN} = 2.0V \text{ to } 5.0V$ ,	$T_A = -25$ °C to $+85$ °C	4.825	5.0	5.175	V
Output Voltage (Note 3)	MMN	over full load range, circuit of Figure 2a	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C (Note 1)}$	4.800	5.0	5.200	V
Output Voltage Line Regulation (Note 4)	WW	V <sub>IN</sub> = 2.7V to 4.0V, V <sub>C</sub> circuit of Figure 2a	DUT = 5V, I <sub>LOAD</sub> = 500mA,	W.100	7	OM.T	mV/V
Output Voltage Load Regulation (Note 4)		V <sub>IN</sub> = 2V, V <sub>OUT</sub> = 5V, I circuit of Figure 2a	LOAD = 0mA to 500mA,	NW.19	60	$co_M$	mV/A
Maximum Switch On-Time	t <sub>ON</sub> (max)	100 1	OMIT	12	16	20	μs
Minimum Switch Off-Time	t <sub>OFF</sub> (min)	100X'	WILL W	1.8	2.3	2.8	μs
Efficiency		V <sub>IN</sub> = 4V, V <sub>OUT</sub> = 5V, circuit of Figure 2a	$I_{LOAD} = 500$ mA,	NWW	87	M.Co	%
Defence Vellege	\/	15-5 04	$T_A = -25^{\circ}C \text{ to } +85^{\circ}C$	1.4625	1.5	1.5375	1/
Reference Voltage	VREF	IREF = 0µA	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 1)}$	1.4475	111.7	1.5525	OA
REF Load Regulation		0μA ≤ I <sub>REF</sub> ≤ 100μA	Dr. M.TW	14.	-4	10	mV
REF Line Regulation		3V ≤ V <sub>OUT</sub> ≤ 16.5V	OV.COS TV	11	40	100	μV/V
FB Trip Point Voltage	,,	T <sub>A</sub> = -25°C to +85°C	COM	1.4625	1.5	1.5375	7 CV
(Note 5)	VFB	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (}$	Note 1)	1.4475	1	1.5525	V
ED land Comment	1	$T_A = -25^{\circ}C \text{ to } +85^{\circ}C$	CO TO	4	-4	±20	^
FB Input Current	IFB	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (}$	(Note 1)			±40	nA
SHDN Input High Voltage	ViH	V <sub>OUT</sub> = 1.8V to 16.5V	100Y.	1.6			V
SHDN Input Low Voltage	V <sub>IL</sub>	V <sub>OUT</sub> = 1.8V to 16.5V	M. S. COM.			0.4	V
SHDN Input Current	I <sub>IN</sub>	Vout = 16.5V, SHDN	= 0V or 16.5V			±1	μА

# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{OUT} = 5V, I_{LOAD} = 0mA, T_A = -40^{\circ}C$  to  $+85^{\circ}C$  where indicated.  $T_A = -25^{\circ}C$  to  $+85^{\circ}C$  for all other limits. Typical values are at

PARAMETER	SYMBOL	CC	ONDITIONS	MIN	TYP	MAX	UNITS
Current Limit Trip Loyal	Van	V 2V/+o 1/ EV/	T <sub>A</sub> = -25°C to +85°C	85	100	115	mV
Current-Limit Trip Level	Vcs	$V_{OUT} = 3V \text{ to } 16.5V$	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C \text{ (Note 1)}$	80		120	IIIV
CS Input Current	lcs		ALMAN SA COM	- XX	0.01	±1	μА
EXT Rise Time	11.	Vout = 5V, 1nF from	EXT to GND	N.F.	50		- X 5.N
EXT Fall Time	N.C.	Vout = 5V, 1nF from	EXT to GND	TI	50	V	ns
EXT On-Resistance	100	EXT = high or low	TINW. TO ST CO	) LAY.	15	30	Ω

Note 1: Limits over this temperature range are guaranteed by design.

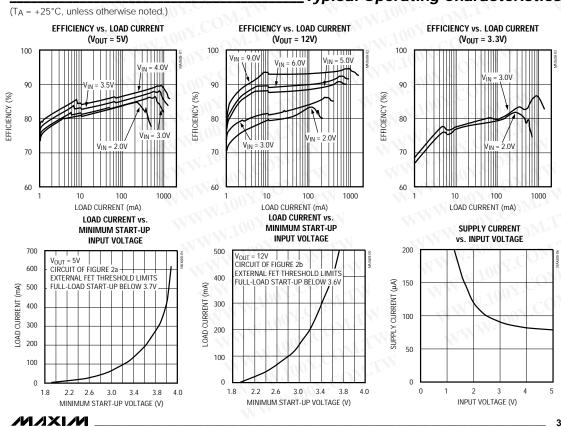
Note 2: The MAX608 must be operated in bootstrapped mode with OUT connected to the DC-DC circuit output. The minimum output voltage set point is +3V.

Note 3: Output voltage guaranteed using preset voltages. See Figures 4a-4d for output current capability versus input voltage.

Note 4: Output voltage line and load regulation depend on external circuit components.

Note 5: Operation in the external-feedback mode is guaranteed to be accurate to the VFB trip level, and does not include resistor tolerance.

### Typical Operating Characteristics



# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### Typical Operating Characteristics (continued)

 $(T_A = +25^{\circ}C, unless otherwise noted.)$ REFERENCE OUTPUT RESISTANCE vs. TEMPERATURE REFERENCE vs. TEMPERATURE EXT RISE/FALL TIME vs. SUPPLY VOLTAGE 250 1.506 TANCE (Ω) 1.504 EXT RISE/FALL TIME (ns) 001 000 000 200 C<sub>EXT</sub> = 2200pF 1.502 C<sub>EXT</sub> = 1000pF RESIS 1.500 1.498 C<sub>EXT</sub> = 470pF 150 REFERENCE OUTPUT  $C_{EXT} = 100pF$ 100 1.496 50 50 1.494 1.492 0 -60 -40 -20 0 20 40 60 80 100 120 140 -60 -40 -20 0 20 40 60 80 100 120 140 TEMPERATURE (°C) TEMPERATURE (°C) SUPPLY VOLTAGE (V) MAXIMUM SWITCH ON-TIME vs. TEMPERATURE MINIMUM SWITCH OFF-TIME vs. TEMPERATURE SHUTDOWN CURRENT vs. TEMPERATURE 16.5 2.30 4.0 3.5 (hA) 3.0 <sup>†</sup>OFF(min) (µs) SHUTDOWN CURRENT 2.5 2.0 1.5 1.0 0.5 2.20 -60 -30 30 60 120 -60 -30 30 60 120 150 90 -60 -40 -20 0 20 40 60 80 100 120 140 90 TEMPERATURE (°C) TEMPERATURE (°C) TEMPERATURE (°C) MEDIUM-LOAD SWITCHING WAVEFORMS **HEAVY-LOAD SWITCHING WAVEFORMS**  $(V_{OUT} = 5V)$  $V_{OUT}$ 

B = INDUCTOR CURRENT, 1A/div C = V<sub>OUT</sub> RIPPLE, 50mV/div, AC-COUPLED  $V_{IN} = 3V$ ,  $I_{OUT} = 490mA$ ,  $V_{OUT} = 5V$ A = FXT VOI TAGE, 5V/div

B = INDUCTOR CURRENT, 1A/div

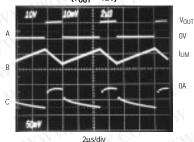
C = V<sub>OUT</sub> RIPPLE, 50mV/div, AC-COUPLED

### 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### Typical Operating Characteristics (continued)

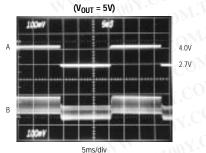
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

### HEAVY-LOAD SWITCHING WAVEFORMS (V<sub>OUT</sub> = 12V)



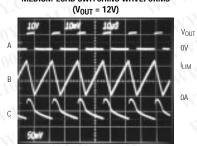
V<sub>IN</sub> = 4V, I<sub>OUT</sub> = 490mA, V<sub>OUT</sub> = 12V A = EXT VOLTAGE, 10V/div B = INDUCTOR CURRENT, 1A/div C = V<sub>OUT</sub> RIPPLE, 50mV/div, AC-COUPLED

### LINE-TRANSIENT RESPONSE



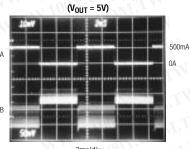
 $I_{OUT}$  = 500mA,  $V_{OUT}$  = 5V A =  $V_{IN}$ , 2.7V TO 4.0V, 1V/div B =  $V_{OUT}$  RIPPLE, 100mV/div, AC-COUPLED

### MEDIUM-LOAD SWITCHING WAVEFORMS



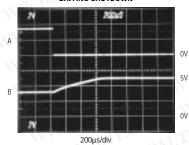
$$\begin{split} &10\mu\text{s/div}\\ V_{\text{IN}} = 4V\text{, } I_{\text{OUT}} = 300\text{mA, } V_{\text{OUT}} = 12V\\ A = \text{EXT VOLTAGE, } 10V/\text{div}\\ B = \text{INDUCTOR CURRENT, } 1A/\text{div}\\ C = V_{\text{OUT}} \text{ RIPPLE, } 50\text{mV/div, } \text{AC-COUPLED} \end{split}$$

### LOAD-TRANSIENT RESPONSE



$$\begin{split} &V_{IN}=2V,\,V_{OUT}=5V\\ &A=LOAD\;CURRENT,\,0mA\;TO\;500mA,\,500mA/div\\ &B=V_{OUT}\;RIPPLE,\,50mV/div,\,AC-COUPLED \end{split}$$

### **EXITING SHUTDOWN**



$$\begin{split} &I_{OUT} = 500\text{mA}, \ V_{IN} = 3.5\text{V} \\ &A = \text{SHDN}, \ 2\text{V/div} \\ &B = V_{OUT}, \ 2\text{V/div} \end{split}$$

# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### \_Pin Description

PIN	NAME	FUNCTION			
1	EXT	Gate Drive for External N-Channel Power Transistor			
2	OUT	Power-Supply and Voltage-Sense Input. Always connect OUT to circuit output.			
3	FB	Feedback Input for Adjustable-Output Operation. Connect to ground for fixed-output operation.  Use a resistor divider network to adjust the output voltage. See Setting the Output Voltage section.			
4	SHDN	Active-High TTL/CMOS Logic-Level Shutdown Input. In shutdown mode, V <sub>OUT</sub> is a diode drop below the input voltage (due to the DC path from the input voltage to the output). Connect to ground for normal operation.			
5	REF	1.5V Reference Output that can source 100 $\mu$ A for external loads. Bypass to GND with 0.1 $\mu$ F. The reference is disabled in shutdown.			
6	AGND	Analog Ground			
7	GND	High-Current Ground Return for the Output Driver			
8	cs	Positive Input to the Current-Sense Amplifier. Connect the current-sense resistor between CS and AGND.			

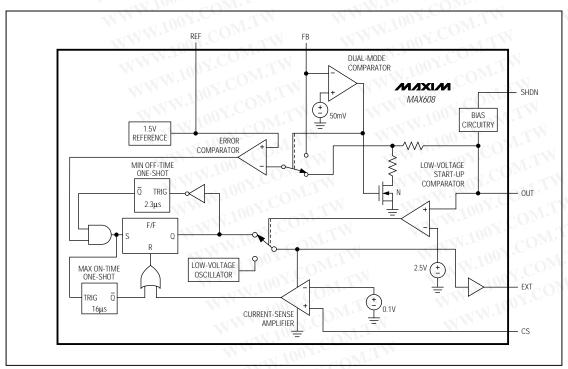


Figure 1. Functional Diagram

# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

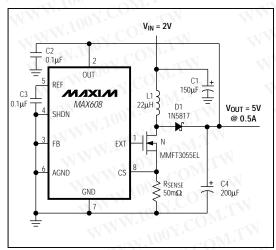


Figure 2a. 5V Preset Output

# $\begin{array}{c} V_{IN} = 2V \\ & \begin{array}{c} C_{2} \\ \hline \\ C_{3} \\ \hline \\ C_{3} \\ \hline \\ C_{3} \\ \hline \\ C_{3} \\ \hline \\ C_{4} \\ \hline \\ C_{5} \\ \hline \\ C_{5} \\ \hline \\ C_{6} \\ \hline \\ C_{7} \\ \hline \\ C_{8} \\ \hline \\ C_{1} \\ \hline \\ C_{2} \\ \hline \\ C_{1} \\ \hline \\ C_{2} \\ \hline \\ C_{1} \\ \hline \\ C_{2} \\ \hline \\ C_{2} \\ \hline \\ C_{3} \\ \hline \\ C_{4} \\ \hline \\ C_{4} \\ \hline \\ C_{4} \\ \hline \\ C_{5} \\ \hline \\ C_$

Figure 2b. 12V Output

### Detailed Description

The MAX608 is a BiCMOS, step-up, switch-mode power-supply controller that provides a preset 5V output, in addition to adjustable-output operation. Its unique control scheme combines the advantages of pulse-frequency modulation (low supply current) and pulse-width modulation (high efficiency with heavy loads), providing high efficiency over a wide output current range, as well as increased output current capability over previous PFM devices. In addition, the external sense resistor and power transistor allow the user to tailor the output current capability for each application. Figure 1 shows the MAX608 functional diagram. The device has a shutdown mode that reduces the supply current to 5µA max

Figure 2 shows the standard application circuits. The IC is powered from the output, and the input voltage range is 1.8V to  $V_{OUT}$  (this configuration is commonly known as bootstrap operation). The voltage applied to the gate of the external power transistor is switched from  $V_{OUT}$  to ground.

The MAX608's output voltage can be set to 5V by connecting FB to ground; it can also be adjusted from 3V to 16.5V using external resistors. Use 1% external feedback resistors when operating in adjustable-output mode (Figures 2b, 2c) to achieve an overall output voltage accuracy of  $\pm 5\%$ .

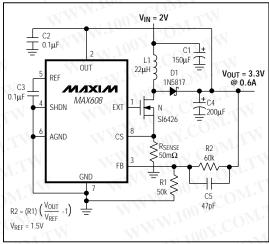


Figure 2c. 3.3V Output

### **PFM Control Scheme**

The MAX608 uses a proprietary current-limited PFM control scheme to provide high efficiency over a wide range of load currents. This control scheme combines the ultralow supply current of PFM converters (or pulse skippers) with the high full-load efficiency of PWM converters.

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# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

Unlike traditional PFM converters, the MAX608 uses a sense resistor to control the peak inductor current. The device also operates with high switching frequencies (up to 300kHz), allowing the use of miniature external components.

As with traditional PFM converters, the power transistor is not turned on until the voltage comparator senses the output is out of regulation. However, unlike traditional PFM converters, the MAX608 switch uses the combination of a peak current limit and a pair of one-shots that set the maximum on-time (16µs) and minimum off-time (2.3µs); there is no oscillator. Once off, the minimum off-time one-shot holds the switch off for 2.3µs. After this minimum time, the switch either 1) stays off if the output is in regulation, or 2) turns on again if the output is out of regulation.

The control circuitry allows the IC to operate in continuous-conduction mode (CCM) while maintaining high efficiency with heavy loads. When the power switch is turned on, it stays on until either 1) the maximum ontime one-shot turns it off (typically 16µs later), or 2) the switch current reaches the peak current limit set by the current-sense resistor.

The MAX608 switching frequency is variable (depending on load current and input voltage), causing variable switching noise. However, the subharmonic noise generated does not exceed the peak current limit times the filter capacitor equivalent series resistance (ESR). For example, when generating a 5V output at 500mA from a 2V input, only 75mV of output ripple occurs, using the circuit of Figure 2a.

### Low-Voltage Start-Up Oscillator

The MAX608 features a low input voltage start-up oscillator that guarantees start-up with no load for input voltages down to 1.8V. At these low voltages, the output voltage is not large enough for proper error-comparator operation and internal biasing. The start-up oscillator has a fixed 50% duty cycle and the MAX608 disregards the error-comparator output when the output voltage is less than 2.5V. Above 2.5V, the error-comparator and normal one-shot timing circuitry are used.

### Shutdown Mode

When SHDN is high, the MAX608 enters shutdown mode. In this mode, the internal biasing circuitry is turned off (including the reference), and VouT falls to a diode drop below VIN (due to the DC path from the input to the output). In shutdown mode, the supply current drops to less than  $5\mu A$ . SHDN is a TTL/CMOS logic-level input. Connect SHDN to GND for normal operation.

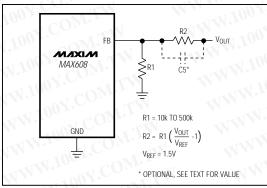


Figure 3. Adjustable Output Circuit

### Design Procedure

### Setting the Output Voltage

The MAX608's output voltage is preset to 5V (FB = 0V), or it can be adjusted from 16.5V down to 3V using external resistors R1 and R2, configured as shown in Figure 3. For adjustable-output operation, select feedback resistor R1 in the  $10k\Omega$  to  $500k\Omega$  range. R2 is given by:

$$R2 = (R1) \left( \frac{V_{OUT}}{V_{RFF}} - 1 \right)$$

where VREF equals 1.5V

OUT must always be connected to the circuit output.

Figure 2 shows various circuit configurations for preset/adjustable operation.

### Determining RSENSE

Use the theoretical output current curves shown in Figures 4a–4d to select RSENSE. They are derived using the minimum (worst-case) current-limit comparator threshold value over the extended temperature range (-40°C to +85°C). No tolerance was included for RSENSE. The voltage drop across the diode is assumed to be 0.5V, and the drop across the power switch rDS(ON) and coil resistance is assumed to be 0.3V.

### Determining the Inductor (L)

Practical inductor values range from 10µH to 300µH. 22µH is a good choice for most applications. In applications with large input/output differentials, the IC's output-current capability will be much less when the inductance value is too low, because the IC will always operate in discontinuous mode. If the inductor value is too low, the

### 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

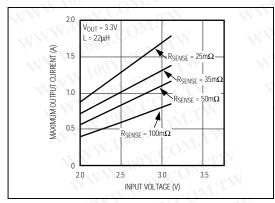


Figure 4a. Maximum Output Current vs. Input Voltage ( $V_{OUT} = 3.3V$ )

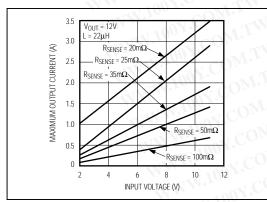


Figure 4c. Maximum Output Current vs. Input Voltage (VOUT = 12V)

current will ramp up to a high level before the current-limit comparator can turn off the switch. The minimum on-time for the switch (toN(min)) is approximately  $2\mu s$ ; select an inductor that allows the current to ramp up to  $I_{LIM}$ .

The standard operating circuits use a  $22\mu H$  inductor. If a different inductance value is desired, select L such that:

$$L \ge \frac{V_{IN}(max) \times 2\mu s}{I_{LIM}}$$

Larger inductance values tend to increase the start-up time slightly, while smaller inductance values allow the coil current to ramp up to higher levels before the switch turns off, increasing the ripple at light loads.

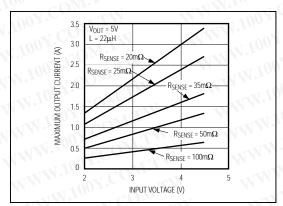


Figure 4b. Maximum Output Current vs. Input Voltage (Vout = 5V)

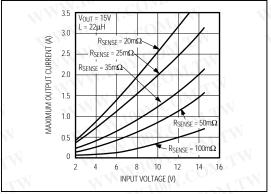


Figure 4d. Maximum Output Current vs. Input Voltage (VOLT = 15V)

Inductors with a ferrite core or equivalent are recommended; powder iron cores are not recommended for use with high switching frequencies. Make sure the inductor's saturation current rating (the current at which the core begins to saturate and the inductance starts to fall) exceeds the peak current rating set by RSENSE. However, it is generally acceptable to bias the inducton into saturation by approximately 20% (the point where the inductance is 20% below the nominal value). For highest efficiency, use a coil with low DC resistance, preferably under 20m $\Omega$ . To minimize radiated noise, use a toroid, a pot core, or a shielded coil.

Table 1 lists inductor suppliers and specific recommended inductors.

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# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

### **Power Transistor Selection**

Use an N-channel MOSFET power transistor with the MAX608

Use logic-level or low-threshold N-FETs to ensure the external N-channel MOSFET (N-FET) is turned on completely and that start-up occurs. N-FETs provide the highest efficiency because they do not draw any DC gate-drive current.

When selecting an N-FET, some important parameters to consider are the total gate charge  $(Q_g)$ , on-resistance  $(r_{DS(ON)})$ , reverse transfer capacitance  $(C_{RSS})$ , maximum drain to source voltage  $(V_{DS}$  max), maximum gate to source voltage  $(V_{GS}$  max), and minimum threshold voltage  $(V_{TH}$  min).

 ${\rm Q}_g$  takes into account all capacitances associated with charging the gate. Use the typical  ${\rm Q}_g$  value for best results; the maximum value is usually grossly overspecified since it is a guaranteed limit and not the measured value. The typical total gate charge should be 50nC or less. With larger numbers, the EXT pins may not be able to adequately drive the gate. The EXT risefall time varies with different capacitive loads as shown in the *Typical Operating Characteristics*.

The two most significant losses contributing to the N-FET's power dissipation are  $I^2R$  losses and switching losses. Select a transistor with low  $r_{DS(ON)}$  and low  $C_{RSS}$  to minimize these losses.

Determine the maximum required gate-drive current from the  $\mathsf{Q}_g$  specification in the N-FET data sheet.

Select an N-FET with a BVDSS > VOUT, BVGSS > VOUT, and a minimum V<sub>TH</sub> of 0.5V below the minimum input voltage.

When using a power supply that decays with time (such as a battery), the N-FET transistor will operate in its linear region when the voltage at EXT approaches the threshold voltage of the FET, dissipating excessive power. Prolonged operation in this mode may damage the FET. To avoid this condition, make sure VEXT is above the VTH of the FET, or use a voltage detector (such as the MAX8211) to put the IC in shutdown mode once the input supply voltage falls below a predetermined minimum value. Excessive loads with low input voltages can also cause this condition.

The MAX608's maximum allowed switching frequency during normal operation is 300kHz. However, at startup, the maximum frequency can be 500kHz, so the maximum current required to charge the N-FET's gate is f(max) x Qg(typ). Use the typical Qg number from the transistor data sheet. For example, the MMFT3055EL has a Qg(typ) of 7nC (at VGs = 5V), therefore the current required to charge the gate is:

 $I_{GATE}$  (max) = (500kHz) (7nC) = 3.5mA.

Figure 2a's application circuit uses a 4-pin MMFT3055EL surface-mount N-FET that has  $150m\Omega$  on-resistance with 4.5V VGS, and a guaranteed VTH of less than 2V. Figure 2c's application circuit uses an Si6426DQ logic-level N-FET with a threshold voltage (VTH) of 1V.

### **Diode Selection**

The MAX608's high switching frequency demands a high-speed rectifier. Schottky diodes such as the 1N5817–1N5822 are recommended. Make sure the Schottky diode's average current rating exceeds the peak current limit set by RSENSE, and that its breakdown voltage exceeds VOUT. For high-temperature applications, Schottky diodes may be inadequate due to their high leakage currents; high-speed silicon diodes such as the MUR105 or EC11FS1 can be used instead. At heavy loads and high temperatures, the benefits of a Schottky diode's low forward voltage may outweigh the disadvantage of high leakage current.

### Capacitor Selection

### **Output Filter Capacitor**

The primary criterion for selecting the output filter capacitor (C4) is low effective series resistance (ESR). The product of the peak inductor current and the output filter capacitor's ESR determines the amplitude of the ripple seen on the output voltage. Two OS-CON  $100\mu F,\,16V$  output filter capacitors in parallel with  $35m\Omega$  of ESR each typically provide 75mV ripple when stepping up from 2V to 5V at 500mA (Figure 2a). Smaller-value and/or higher-ESR capacitors are acceptable for light loads or in applications that can tolerate higher output ripple.

Since the output filter capacitor's ESR affects efficiency, use low-ESR capacitors for best performance. See Table 1 for component selection.

### Input Bypass Capacitors

The input bypass capacitor (C1) reduces peak currents drawn from the voltage source and also reduces noise caused by the switching action of the MAX608 at the voltage source. The input voltage source impedance determines the size of the capacitor required at the OUT input. As with the output filter capacitor, a low-ESR capacitor is recommended. For output currents up to 1A, 150µF (C1) is adequate, although smaller bypass capacitors may also be acceptable.

Bypass the IC with a  $0.1\mu F$  ceramic capacitor (C2) placed as close as possible to the OUT and GND pins.

### Reference Capacitor

Bypass REF with a 0.1µF capacitor (C3). REF can source up to 100µA of current for external loads.

# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

PRODUCTION	INDUCTORS	CAPACITORS	TRANSISTORS	DIODES
Surface Mount	Sumida CD54 series CDR125 series Coiltronics CTX20 series Coilcraft DO3316 series DO3340 series	Matsuo 267 series Sprague 595D series AVX TPS series Sanyo OS-CON series	Siliconix Si9410DY Si4410DY Si6426DQ Si6946DQ Motorola MTP3055EL MTD20N03HDL MMFT3055ELT1	Central Semiconductor CMPSH-3 CMPZ5240 Nihon EC11 FS1 series (high speed silicon) Motorola MBRS1100T3 MMBZ5240BL
Through Hole	Sumida RCH855 series RCH110 series	Sanyo OS-CON series Nichicon PL series	M.M.100X'COW	Motorola 1N5817-1N5822 MUR105 (high-speed silicon)

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### Feed-Forward Capacitor

When adjusting the output voltage, it may be necessary to parallel a 47pF to 220pF capacitor across R2, as shown in Figures 2 and 3. Choose the lowest capacitor value that insures stability; high capacitance values may degrade line regulation.

### \_Applications Information

### Starting Up Under Load

The *Typical Operating Characteristics* show the Start-Up Voltage vs. Load Current graphs for 5V and 12V output voltages. These graphs depend on the type of power switch used. The MAX608 is not designed to start up under full load with low input voltages.

### Layout Considerations

Due to high current levels and fast switching waveforms, which radiate noise, proper PC board layout is essential. Protect sensitive analog grounds by using a star ground configuration. Minimize ground noise by connecting GND, the input bypass capacitor ground lead, and the output filter capacitor ground lead to a single point (star ground configuration). Also, minimize lead lengths to reduce stray capacitance, trace resistance, and radiated noise. Place input bypass capacitor C2 as close as possible to OUT and GND.

If an external resistor divider is used (Figures 2 and 3), the trace from FB to the resistors must be extremely short.

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MIXIM

# 5V or Adjustable, Low-Voltage, Step-Up DC-DC Controller

# Chip Topography EXT OUT CS O.126" (3.200mm) GND AGND AGND REF (2.032mm)

TRANSISTOR COUNT: 501 SUBSTRATE CONNECTED TO OUT

### Package Information

